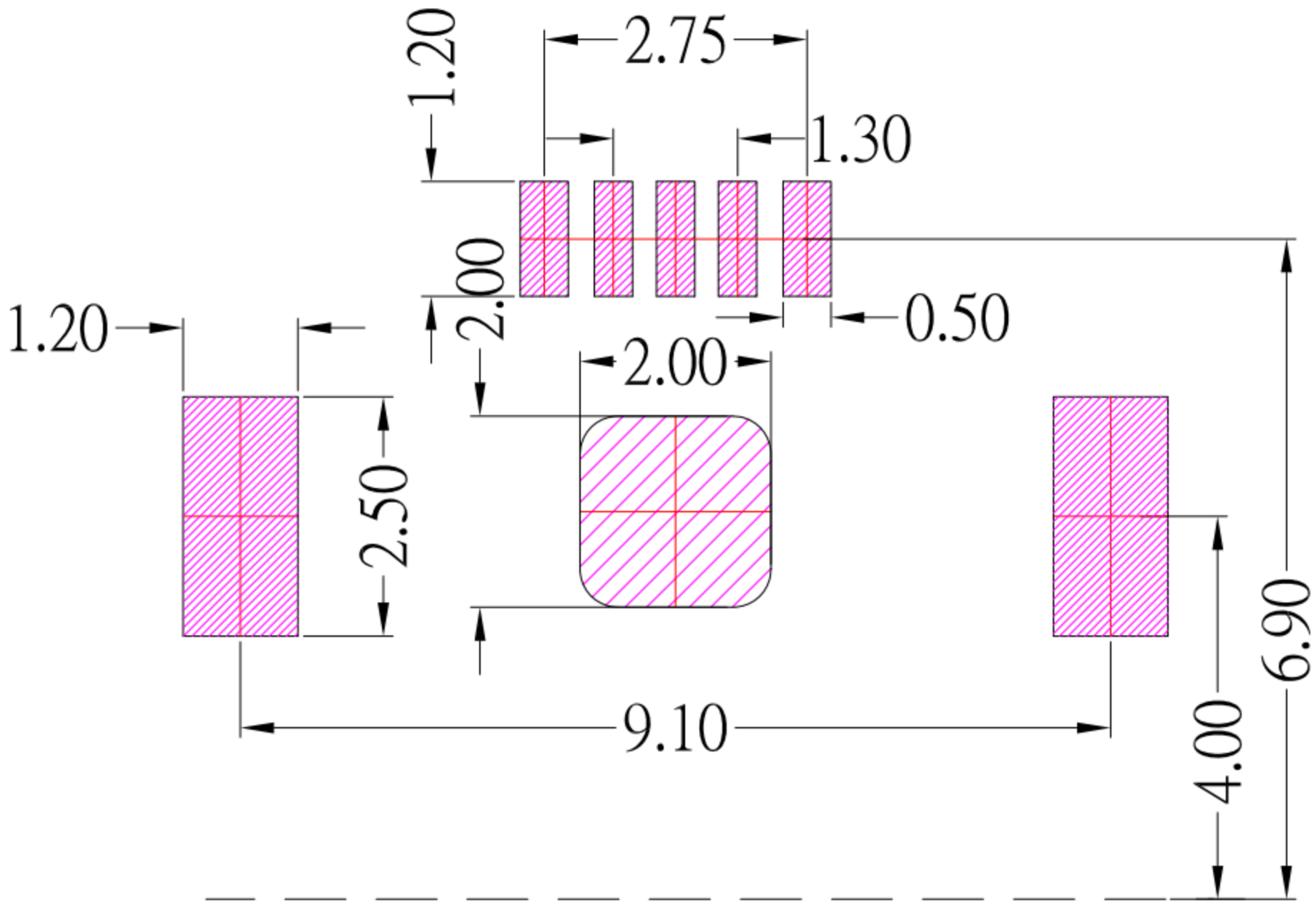
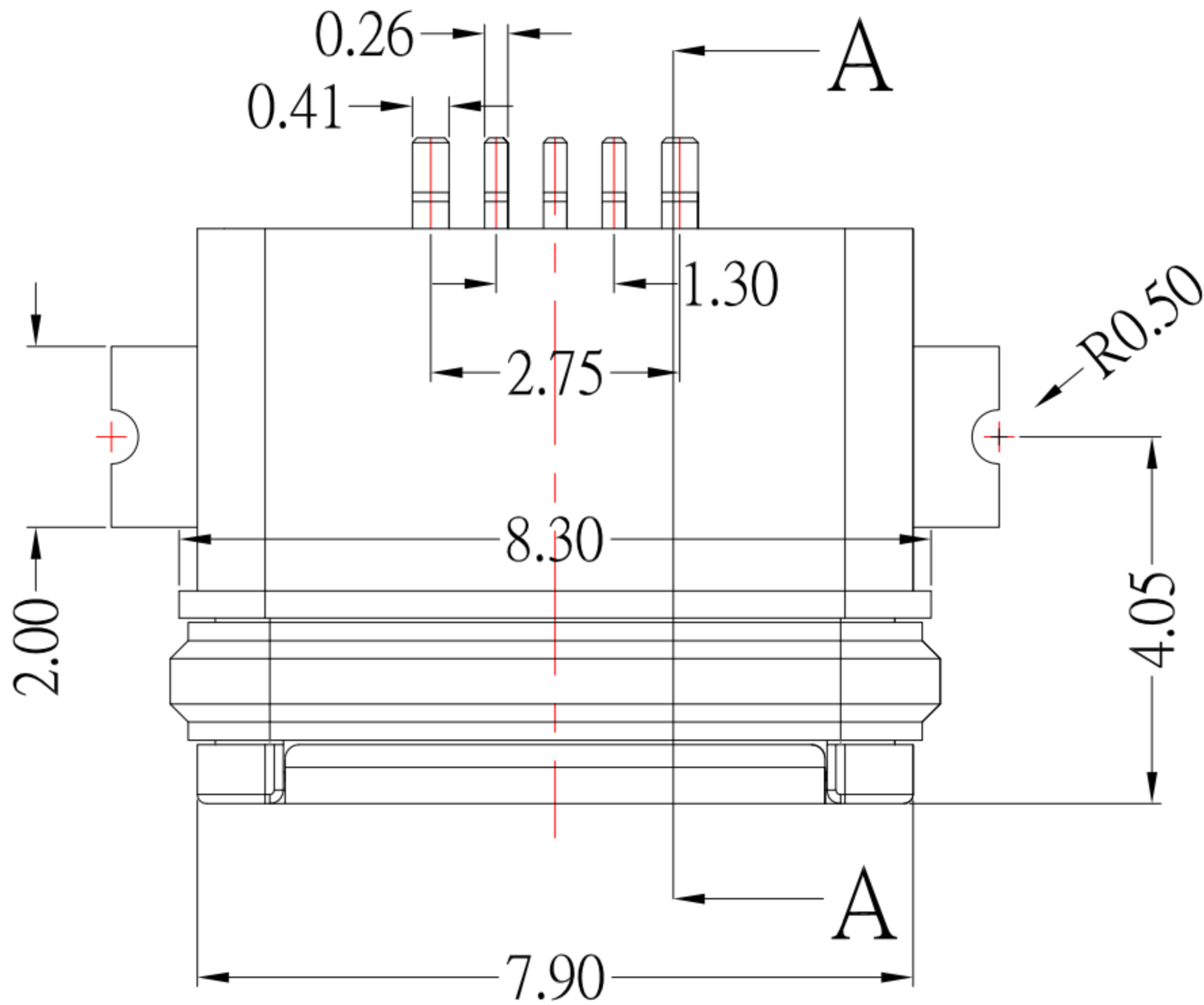
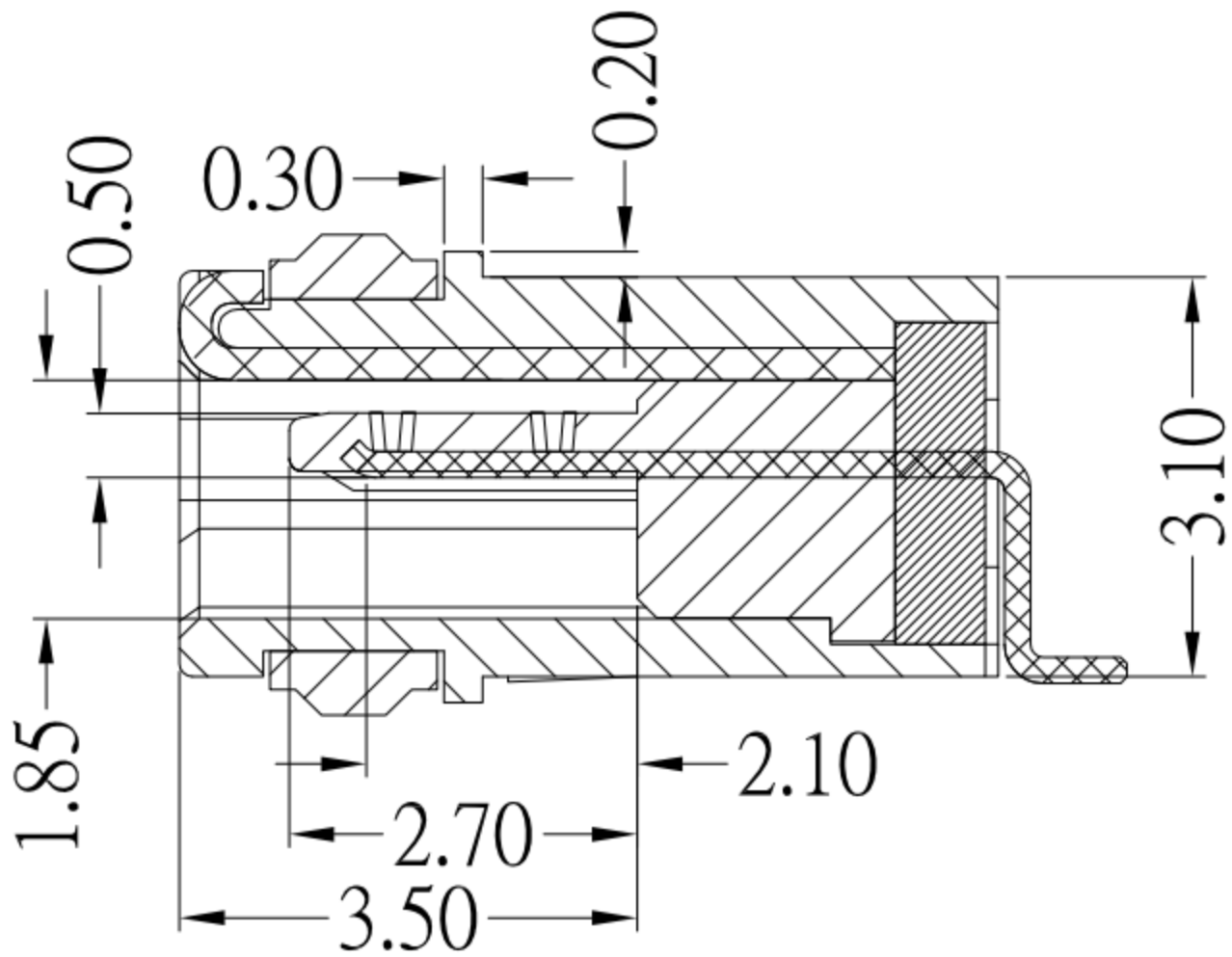
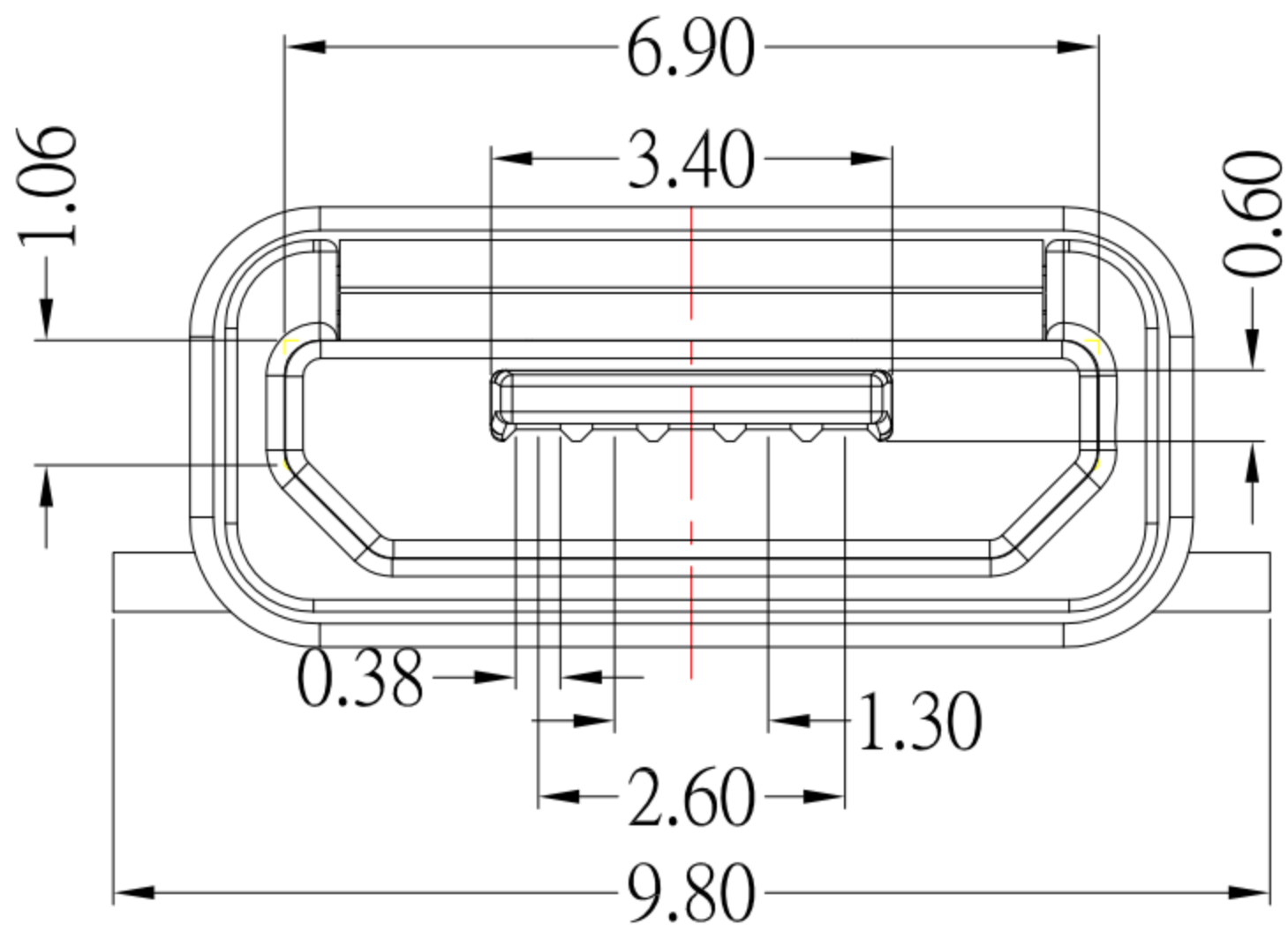
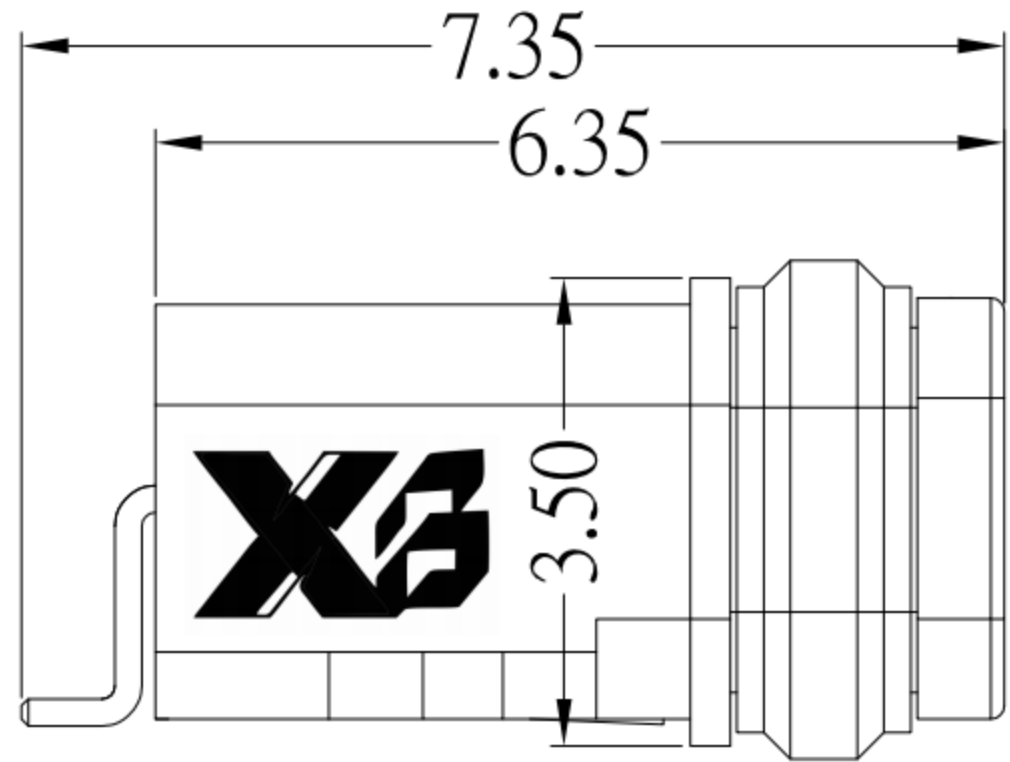


IPX7



P.C.B LAYOUT MOUNTING PATTERN

- NOTES:
- MATERIAL:
- 1.1 HOUSING: HIGH TEMPERATURE
 - 1.2 CONTACT: COPPER ALLOY
 - 1.3 SHELL: SUS
- FINISH:
- 2.1 CONTACT: PLATED GOLD IN MATING AREA ;
GOLD PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL
 - 2.2 SHELL: NICKEL UNDER PLATED SURFACE LAYER
- 3.SPECIFICATION:
- 3.1 RATING: 1.8A(PIN1&5) , 1.0A(PIN2&3&4)
 - 3.2 DIELECTRIC WITHSSTANDING VOLTAGE: 100 VAC
 - 3.3 CONTACT RESISTANCE: 30 mΩ MAX.
 - 3.4 INSULATION RESISTANCE: 1000 MΩ MIN.
 - 3.5 TEMPERATURE RANG: -30℃ ~ 80℃



A-A



东莞市溪榜电子有限公司

DONG GUAN XI BANG ELECTRONICS CO., LTD

TOLERANCE UNLESS OTHERWISE STATED :	Up to 5	±0.2	3RD. ANGEL'S		UNITS	MM
	Above 5 ~ 15	±0.3				
	Above 15 ~ 30	±0.4				
	Above 30 ~ 50	±0.5				
	Angle	±0.3°				

ITEM NO.	DESCRIPTION	DRAWN	DATE

DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR	
Jack Lu	12/06/19					
CHECKED BY:	DATE	FINISH		MODLE	MICRO USB 5PF B TYPE H 3.95 IPX7	
Jacky Chen	12/06/19	SCALE	1 : 1	DWG NO.	MRUSB-5B-WP16-S347	SIZE
APPROVED BY:	DATE					A4
Tony Kao	12/06/19	SHEET NO.	1 of 1	PART NO.	MRUSB-5B-WP16-S347	VER
						R